



# RE4-1 & RE3-1 a proposal for the Phase II

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# Muon Upgrade



## **RPC community is working on the RE4-1 & RE3-1 phase II upgrade**

- A preliminary version of the proposal has been included in present version of the muon TP.
  - A preliminary cost book has been prepared for the April RRB meeting.
  - An RPC R&D proposal document will be circulated in May 2014.
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- **An R&D activity on the next generation of Bakelite RPC is starting this year with the following main goals:**
    - Test the present detector up to the 3000 fb<sup>-1</sup> needed for HL-LHC
    - Improve the present design thanks to the lesson learned during LS1
    - Design a iRPC (thin gap, new front-end electronic, eco-gas, multi-gap....) to be able to run in the inner ring of the two outermost disks at a maximum rate of about 1 KHz/cm<sup>2</sup> and an Integrated charge of about 1 C/cm<sup>2</sup>.



# Basic upgrade info

The two main requirements, described before, can be fulfilled optimizing the **bulk resistivity** of the Bakelite electrodes and the **average charge** generated by the **avalanche**.

- The role of these parameters can be explained looking at the three following equations, obtained using simple electrostatic model:
  - The **time constant** of an elementary cell involved in the avalanche process:  
 $t = \epsilon_0 (\epsilon_r + 2) r$
  - The **area** of the “cell” concerned in the discharge:  $S = 2\langle q \rangle / \epsilon_0 E = 2\langle q \rangle d / \epsilon_0 V_d$
  - The **rate capability** of the single cell:  $r = 1/St$

Where  $\langle q \rangle$  is the average charge per avalanche (C),  $r$  is the rate (Hz/cm<sup>2</sup>),  $r$  is bulk resistivity (Ωcm),  $s_e$  is the electrode thickness (cm),  $\epsilon_r$  is the relative dielectric constant of the electrode,  $E$  is the electric field inside the gas,  $V_d$  is the voltage drop that stop the avalanche in the cell and  $d$  is the gas gap width.

- To increase the **rate capability** and reach the kHz/cm<sup>2</sup> foreseen in the high eta region we can decrease the resistivity of the Bakelite electrode and reduce the average charge  $\langle q \rangle$  associated to the avalanche. A resistivity around  $10^{10}$  Ωcm can be produced taking into account that for the RE4 region we were already able to reach the  $2-3 \times 10^{10}$  Ωcm.
- A **thinner gas gap** (from 2 mm to 1.5-1.0 mm) and a **more performing front-end chip** are two possible aspects to be investigated to reduce the average charge produce in an avalanche and at same time the power consumption of the detector.



# Some useful numbers

- **RE4 system** consists of 144 chambers and cover a region of about 230 m<sup>2</sup>.
  - Average chamber area is about 1.6 m<sup>2</sup>.
- Chamber cost was about **2.20 MCHF** (half of the total)
- Total cost is 4.2 MCHF
- **RE4-1 and RE3-1** cover a region of 115 m<sup>2</sup>
  - 72 chambers (20°) needed
  - Average chamber area is about 1.6 m<sup>2</sup>.
- We can apply a factor 2 to the cost of the chamber construction and to some services (HV, LV and Gas)



# Estimated cost

- Chambers cost is about 1.43 MCHF
- Electronics has been scaled with number of channels.
- Services and installation costs are the same of RE4.
- A contingency of about 10% has been included in the total cost.
- Most of the numbers have been easily extrapolated from RE4 project and are very close to the today cost.

## Summary

Chamber	1430
Electronics	415
Services	601
Installation	290
Contingency	273,6
<b>TOTAL</b>	<b>3010</b>

## Note:

20° chamber mode:		# component	# incl. Spare
# chambers		72	100
# strip per chamber		96	
# FEBs		288	300
# HV channels		36	40
# HV boards		7,2	8



# Detailed costs

item	quantity	cost
<b>Detector 20° size</b>		<b>1000</b>
Bakelite	300	200
Chamber mechanics/strips	100	150
Gap	600	400
Chamber cooling circuit	100	100
Varie		100
R&D		50
<b>FE Electronics</b>		<b>200</b>
FE boards/ distribution board	400	160
Strip connect. To FE		40
<b>Off detector electronics</b>		<b>215</b>
Link Boards	100	100
Control Boards	25	35
LB integration	manpower	80
Link Box	10	10
Trigger		
<b>Services</b>		<b>450</b>
HV & LV systems	40 channels	200
HV&LV integration	manpower	30
Cooling System		100
Gas system		100
Miscellanea		20

<b>Cables</b>		<b>151</b>
Signal		30
HV&LV DCS		20
LB Fiber		10
HV connector		50
LV connector		1
Connectorisation (Manpower)		40
<b>Chamber assem&amp;test</b>		<b>430</b>
Infrastrutture at site		100
Assembly consumable at sites		100
Ass&test manpower at 904		100
Shipment to CERN		80
Chamber test at 904		50
<b>Logistic &amp; Installation</b>		<b>290</b>
Consumable installation		60
Mechanics installation		100
Manpower installation		80
Manpoower commissioning		50
<b>Contingency</b>		<b>273,6</b>
<b>Total cost</b>		<b>3010</b>



# Conclusion

- Present RPCs have been certified up to  $400 \text{ Hz/cm}^2$  and will be test up to  $1 \text{ kHz/cm}^2$  at GIF++.
- A lower resistivity Bakelite foils and a more performing electronics will be studied.
- At same time a thin gap (eventually multi-gap) detector will be designed and tested at GIF++ in the next 2 years.
- A preliminary table cost have been produced (uncertainty of 10%) in details.
- TP and R&D document will be ready in few months.
- More simulation studies are going on.
- RPC institutions are thinking about the next upgrades and in June 2014 we will have the full list of interested people.